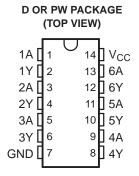
SCLS499C-MAY 2003-REVISED JUNE 2006

#### **FEATURES**

- Controlled Baseline
  - One Assembly/Test Site, One Fabrication Site
- Extended Temperature Performance of −55°C to 125°C
- Enhanced Diminishing Manufacturing Sources (DMS) Support
- Enhanced Product-Change Notification
- Qualification Pedigree (1)
- Typical V<sub>OLP</sub> (Output Ground Bounce)
   <0.8 V at V<sub>CC</sub> = 3.3 V, T<sub>A</sub> = 25°C
- Typical V<sub>OHV</sub> (Output V<sub>OH</sub> Undershoot)
   >2.3 V at V<sub>CC</sub> = 3.3 V, T<sub>A</sub> = 25°C
- Supports Mixed-Mode Voltage Operation on All Ports
- I<sub>off</sub> Supports Partial-Power-Down Mode Operation
- (1) Component qualification in accordance with JEDEC and industry standards to ensure reliable operation over an extended temperature range. This includes, but is not limited to, Highly Accelerated Stress Test (HAST) or biased 85/85, temperature cycle, autoclave or unbiased HAST, electromigration, bond intermetallic life, and mold compound life. Such qualification testing should not be viewed as justifying use of this component beyond specified performance and environmental limits.

- ESD Protection Exceeds JESD 22
  - 2000-V Human-Body Model (A114-A)
  - 200-V Machine Model (A115-A)
  - 1000-V Charged-Device Model (C101)



#### **DESCRIPTION/ORDERING INFORMATION**

This hex Schmitt-trigger inverter is designed for 2-V to 5.5-V V<sub>CC</sub> operation.

The SN74LV14A contains six independent inverters. This device performs the Boolean function  $Y = \overline{A}$ .

This device is fully specified for partial-power-down applications using  $I_{off}$ . The  $I_{off}$  circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

#### **ORDERING INFORMATION**

| T <sub>A</sub> | PACK       | AGE <sup>(1)</sup> | ORDERABLE PART NUMBER | TOP-SIDE MARKING |  |  |
|----------------|------------|--------------------|-----------------------|------------------|--|--|
| -40°C to 105°C | TSSOP - PW | Tape and reel      | SN74LV14ATPWREP       | LV14AEP          |  |  |
| −55°C to 125°C | SOIC - D   | Tape and reel      | SN74LV14AMDREP        | LV14AEP          |  |  |
| -55 C to 125 C | TSSOP - PW | Tape and reel      | SN74LV14AMPWREP       | LV14AEP          |  |  |

(1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

# FUNCTION TABLE (each inverter)

| INPUT<br>A | OUTPUT<br>Y |
|------------|-------------|
| Н          | L           |
| L          | Н           |



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



## LOGIC DIAGRAM, EACH INVERTER (POSITIVE LOGIC)



# **Absolute Maximum Ratings**(1)

over operating free-air temperature range (unless otherwise noted)

|                  |  |  |  | MIN  | MAX                   | UNIT |  |
|------------------|--|--|--|------|-----------------------|------|--|
| $V_{CC}$         | Supply voltage range                               |  |  | -0.5 | 7                     | V    |  |
| VI               | Input voltage range (2)                            |  |  | -0.5 | 7                     | V    |  |
| Vo               | Voltage range applied to any output in the high-in | mpedance or power-off state <sup>(2)</sup> |  | -0.5 | 7                     | V    |  |
| Vo               | Output voltage range <sup>(2)(3)</sup>             |  |  | -0.5 | V <sub>CC</sub> + 0.5 | V    |  |
| $I_{IK}$         | Input clamp current                                | V <sub>I</sub> < 0                         |  |      | -20                   | mA   |  |
| I <sub>OK</sub>  | Output clamp current                               | V <sub>O</sub> < 0                         |  | -50  |                       | mA   |  |
| Io               | Continuous output current                          | $V_O = 0$ to $V_{CC}$                      |  |      | ±25                   | mA   |  |
|                  | Continuous current through V <sub>CC</sub> or GND  |  |  |      | ±50                   | mA   |  |
| 0                | Thermal impedance (4)                              | D package                                  |  |      | 133.5                 | °C/W |  |
| $\theta_{JA}$    | memai impedance · · ·                              | PW package                                 |  |      | 113                   | C/VV |  |
| T <sub>stg</sub> | Storage temperature range                          | Storage temperature range                  |  |      |                       |      |  |

<sup>(1)</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

<sup>(2)</sup> The input and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.

<sup>(3)</sup> This value is limited to 5.5 V maximum.

<sup>(4)</sup> The package thermal impedance is calculated in accordance with JESD 51-7.



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# Recommended Operating Conditions<sup>(1)</sup>

|                 |   |  | MIN                   | MAX                        | UNIT |
|-----------------|---|--|-----------------------|----------------------------|------|
| $V_{CC}$        | Supply voltage  |  | 2                     | 5.5                        | V    |
|                 |   | V <sub>CC</sub> = 2 V                      | 1.5                   |                            |      |
| V               | High level input voltage  | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | V <sub>CC</sub> × 0.7 |                            | V    |
| $V_{IH}$        | High-level input voltage  Low-level input voltage  Input voltage  Output voltage  High-level output current | V <sub>CC</sub> = 3 V to 3.6 V             | V <sub>CC</sub> × 0.7 |                            | V    |
|                 |   | V <sub>CC</sub> = 4.5 V to 5.5 V           | V <sub>CC</sub> × 0.7 |                            |      |
|                 |   | V <sub>CC</sub> = 2 V                      |                       | 0.5                        |      |
| .,              | Law law line of walters   | V <sub>CC</sub> = 2.3 V to 2.7 V           |                       | $V_{\text{CC}} \times 0.3$ | V    |
| $V_{IL}$        | Low-level input voltage   | V <sub>CC</sub> = 3 V to 3.6 V             |                       | $V_{CC} \times 0.3$        | V    |
|                 |   | V <sub>CC</sub> = 4.5 V to 5.5 V           |                       | $V_{CC} \times 0.3$        | •    |
| VI              | Input voltage   |  | 0                     | 5.5                        | V    |
| Vo              | Output voltage  |  | 0                     | $V_{CC}$                   | V    |
|                 |   | V <sub>CC</sub> = 2 V                      |                       | <b>-</b> 50                | μΑ   |
|                 | Low-level input voltage  Input voltage  Output voltage  High-level output current                           | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ |                       | -2                         |      |
| I <sub>OH</sub> | nigii-level output current  | $V_{CC} = 3 \text{ V to } 3.6 \text{ V}$   |                       | 9                          | mA   |
|                 |   | V <sub>CC</sub> = 4.5 V to 5.5 V           |                       | 1.5 < 0.7 < 0.7 < 0.7      |      |
|                 |   | V <sub>CC</sub> = 2 V                      |                       | 50                         | μΑ   |
|                 | Low lovel output ourrent  | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ |                       | 2                          |      |
| I <sub>OL</sub> | Low-level output current  | V <sub>CC</sub> = 3 V to 3.6 V             |                       | 6                          | mA   |
|                 |   | V <sub>CC</sub> = 4.5 V to 5.5 V           |                       | 12                         | •    |
| _               | On another fine arise to an another   | SN74LV14AT                                 | -40                   | 105                        | °C   |
| $T_A$           | Operating free-air temperature  | SN74LV14AM                                 | -55                   | 125                        | J.   |

<sup>(1)</sup> All unused inputs of the device must be held at  $V_{CC}$  or GND to ensure proper device operation. See the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

# SN74LV14A-EP HEX SCHMITT-TRIGGER INVERTER

SCLS499C-MAY 2003-REVISED JUNE 2006



#### **Electrical Characteristics**

over operating free-air temperature range (unless otherwise noted)

| PARAMETER         | TEST CONDITIONS                  | V               | SN74L                 | V14AT   | SN74L                 | V14AM   | UNIT |
|-------------------|----------------------------------|-----------------|-----------------------|---------|-----------------------|---------|------|
| PARAMETER         | TEST CONDITIONS                  | V <sub>cc</sub> | MIN                   | TYP MAX | MIN                   | TYP MAX | UNII |
| V <sub>T+</sub>   |                                  | 2.5 V           |                       | 1.75    |                       | 1.78    |      |
| Positive-going    |                                  | 3.3 V           |                       | 2.31    |                       | 2.31    | V    |
| threshold         |                                  | 5 V             |                       | 3.5     |                       | 3.5     |      |
| V <sub>T-</sub>   |                                  | 2.5 V           | 0.75                  |         | 0.75                  |         |      |
| Negative-going    |                                  | 3.3 V           | 0.99                  |         | 0.97                  |         | V    |
| threshold         |                                  | 5 V             | 1.5                   |         | 1.5                   |         |      |
| $\Delta V_T$      |                                  | 2.5 V           | 0.25                  | 1       | 0.25                  | 1       |      |
| Hysteresis        |                                  | 3.3 V           | 0.33                  | 1.32    | 0.33                  | 1.37    | V    |
| $(V_{T+}-V_{T-})$ |                                  | 5 V             | 0.5                   | 2       | 0.5                   | 2       |      |
|                   | $I_{OH} = -50 \mu A$             | 2 V to 5.5 V    | V <sub>CC</sub> - 0.1 |         | V <sub>CC</sub> - 0.1 |         |      |
| V                 | $I_{OH} = -2 \text{ mA}$         | 2.3 V           | 2                     |         | 2                     |         | V    |
| $V_{OH}$          | $I_{OH} = -6 \text{ mA}$         | 3 V             | 2.48                  |         | 2.48                  |         | V    |
|                   | $I_{OH} = -12 \text{ mA}$        | 4.5 V           | 3.8                   |         | 3.8                   |         |      |
|                   | $I_{OL} = 50 \mu A$              | 2 V to 5.5 V    |                       | 0.1     |                       | 0.1     |      |
| \ <i>/</i>        | $I_{OL} = 2 \text{ mA}$          | 2.3 V           |                       | 0.4     |                       | 0.4     | V    |
| $V_{OL}$          | I <sub>OL</sub> = 6 mA           | 3 V             |                       | 0.44    |                       | 0.44    | V    |
|                   | I <sub>OL</sub> = 12 mA          | 4.5 V           |                       | 0.55    |                       | 0.55    |      |
| I <sub>I</sub>    | $V_1 = V_{CC}$ or GND            | 0 to 5.5 V      |                       | ±1      |                       | ±1      | μΑ   |
| I <sub>cc</sub>   | $V_1 = V_{CC}$ or GND, $I_0 = 0$ | 5.5 V           |                       | 20      |                       | 20      | μΑ   |
| I <sub>off</sub>  | $V_I$ or $V_O = 0$ to 5.5 V      | 0 V             |                       | 5       |                       | 5       | μΑ   |
| C                 | V - V or CND                     | 3.3 V           |                       | 2.3     |                       | 2.3     | nf   |
| $C_{i}$           | $V_I = V_{CC}$ or GND            | 5 V             |                       | 2.3     |                       | 2.3     | pf   |

#### **Switching Characteristics**

over recommended operating free-air temperature range,  $V_{CC}$  = 3.3 V  $\pm$  0.3 V (unless otherwise noted) (see Figure 1)

| PARAMETER       | FROM    | то       | LOAD                   | T,  | <sub>λ</sub> = 25°C |      | MIN    | MAX   | UNIT |
|-----------------|---------|----------|------------------------|-----|---------------------|------|--------|-------|------|
| PARAMETER       | (INPUT) | (OUTPUT) | CAPACITANCE            | MIN | TYP                 | MAX  | IVIIIV | IVIAA | UNII |
| t <sub>pd</sub> | A       | Υ        | C <sub>L</sub> = 50 pF |     | 9.6                 | 16.3 | 1      | 20.4  | ns   |

### **Switching Characteristics**

over recommended operating free-air temperature range,  $V_{\text{CC}}$  = 5 V  $\pm$  0.5 V (unless otherwise noted) (see Figure 1)

| PA | PARAMETER       | FROM    | то       | LOAD          | T,  | չ = 25°C | ;    | MIN    | IN MAX | UNIT |
|----|-----------------|---------|----------|---------------|-----|----------|------|--------|--------|------|
|    | PARAMETER       | (INPUT) | (OUTPUT) | CAPACITANCE   | MIN | TYP      | MAX  | IVIIIV |        | ONII |
|    | t <sub>pd</sub> | Α       | Υ        | $C_L = 50 pF$ |     | 6.7      | 10.6 | 1      | 14     | ns   |



# SN74LV14A-EP HEX SCHMITT-TRIGGER INVERTER

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# Noise Characteristics<sup>(1)</sup>

 $V_{CC}$  = 3.3 V,  $C_L$  = 50 pF,  $T_A$  = 25°C

|                    | PARAMETER                                     | MIN  | TYP  | MAX  | UNIT |
|--------------------|---|------|------|------|------|
| $V_{OL(P)}$        | Quiet output, maximum dynamic V <sub>OL</sub> |      | 0.2  | 8.0  | V    |
| V <sub>OL(V)</sub> | Quiet output, minimum dynamic V <sub>OL</sub> |      | -0.1 | -0.8 | V    |
| $V_{OH(V)}$        | Quiet output, minimum dynamic V <sub>OH</sub> |      | 3.1  |      | V    |
| $V_{IH(D)}$        | High-level dynamic input voltage              | 2.31 |      |      | V    |
| $V_{IL(D)}$        | Low-level dynamic input voltage               |      |      | 0.99 | V    |

<sup>(1)</sup> Characteristics are for surface-mount packages only.

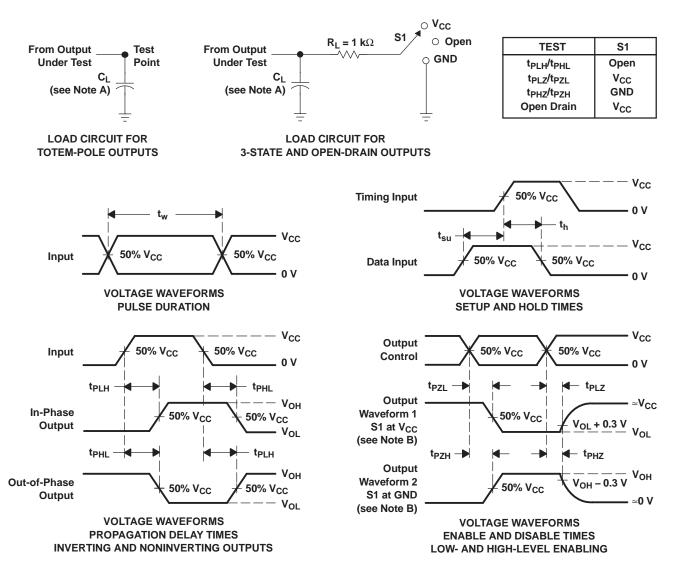
# **Operating Characteristics**

T<sub>A</sub> = 25°C

|          | PARAMETER                     | TEST CONDITIONS                                  | V <sub>CC</sub> | TYP | UNIT |
|----------|-------------------------------|--|-----------------|-----|------|
| _        | Dawar dissination conscitance | C 50 pF f 40 MHz                                 | 3.3 V           | 8.8 | ۲    |
| $C_{pd}$ | Power dissipation capacitance | $C_L = 50 \text{ pF}, \qquad f = 10 \text{ MHz}$ | 5 V             | 9.6 | p⊦   |



#### PARAMETER MEASUREMENT INFORMATION



- NOTES: A. C<sub>L</sub> includes probe and jig capacitance.
  - B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
  - C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  1 MHz,  $Z_O = 50~\Omega$ ,  $t_r \leq$  3 ns,  $t_f \leq$  3 ns.
  - D. The outputs are measured one at a time, with one input transition per measurement.
  - E. t<sub>PLZ</sub> and t<sub>PHZ</sub> are the same as t<sub>dis</sub>.
  - F.  $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .
  - G.  $t_{PHL}$  and  $t_{PLH}$  are the same as  $t_{pd}$ .
  - H. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuits and Voltage Waveforms

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#### PACKAGING INFORMATION

| Orderable part number | Status   | Material type | Package   Pins  | Package qty   Carrier | RoHS | Lead finish/<br>Ball material | MSL rating/<br>Peak reflow | Op temp (°C) | Part marking |
|-----------------------|----------|---------------|-----------------|-----------------------|------|-------------------------------|----------------------------|--------------|--------------|
|                       | (1)      | (2)           |                 |                       | (3)  | (4)                           | (5)                        |              | (6)          |
| SN74LV14AMDREP        | Active   | Production    | SOIC (D)   14   | 2500   LARGE T&R      | Yes  | NIPDAU                        | Level-1-260C-UNLIM         | -55 to 125   | LV14AMEP     |
| SN74LV14AMDREP.A      | Active   | Production    | SOIC (D)   14   | 2500   LARGE T&R      | Yes  | NIPDAU                        | Level-1-260C-UNLIM         | -55 to 125   | LV14AMEP     |
| SN74LV14AMPWREP       | Obsolete | Production    | TSSOP (PW)   14 | -                     | -    | Call TI                       | Call TI                    | -55 to 125   | LV14AEP      |
| SN74LV14ATPWREP       | Active   | Production    | TSSOP (PW)   14 | 2000   LARGE T&R      | Yes  | NIPDAU                        | Level-1-260C-UNLIM         | -40 to 105   | LV14AEP      |
| SN74LV14ATPWREP.A     | Active   | Production    | TSSOP (PW)   14 | 2000   LARGE T&R      | Yes  | NIPDAU                        | Level-1-260C-UNLIM         | -40 to 105   | LV14AEP      |
| V62/03662-01XE        | Active   | Production    | TSSOP (PW)   14 | 2000   LARGE T&R      | Yes  | NIPDAU                        | Level-1-260C-UNLIM         | -40 to 105   | LV14AEP      |
| V62/03662-02YE        | Active   | Production    | SOIC (D)   14   | 2500   LARGE T&R      | Yes  | NIPDAU                        | Level-1-260C-UNLIM         | -55 to 125   | LV14AMEP     |

<sup>(1)</sup> Status: For more details on status, see our product life cycle.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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<sup>(2)</sup> Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

<sup>(4)</sup> Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

## PACKAGE OPTION ADDENDUM

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#### OTHER QUALIFIED VERSIONS OF SN74LV14A-EP:

• Automotive : SN74LV14A-Q1

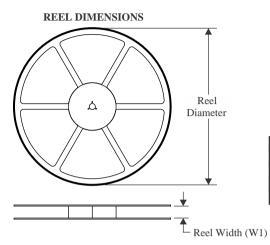
NOTE: Qualified Version Definitions:

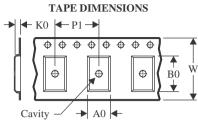
- Catalog TI's standard catalog product
- Automotive Q100 devices qualified for high-reliability automotive applications targeting zero defects

# **PACKAGE MATERIALS INFORMATION**

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#### TAPE AND REEL INFORMATION





| A0 | Dimension designed to accommodate the component width     |
|----|---|
| В0 | Dimension designed to accommodate the component length    |
| K0 | Dimension designed to accommodate the component thickness |
| W  | Overall width of the carrier tape                         |
| P1 | Pitch between successive cavity centers                   |

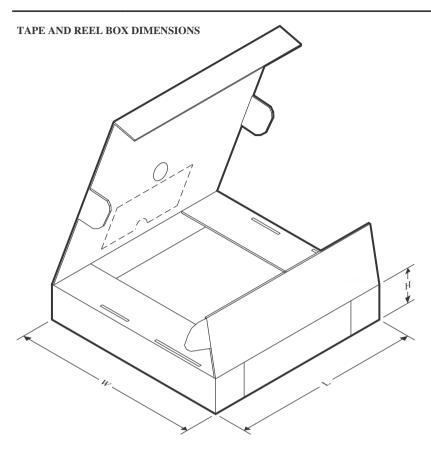
#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

| Device          | Package<br>Type | Package<br>Drawing |    | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
|-----------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| SN74LV14AMDREP  | SOIC            | D                  | 14 | 2500 | 330.0                    | 16.4                     | 6.5        | 9.0        | 2.1        | 8.0        | 16.0      | Q1               |
| SN74LV14ATPWREP | TSSOP           | PW                 | 14 | 2000 | 330.0                    | 12.4                     | 6.9        | 5.6        | 1.6        | 8.0        | 12.0      | Q1               |

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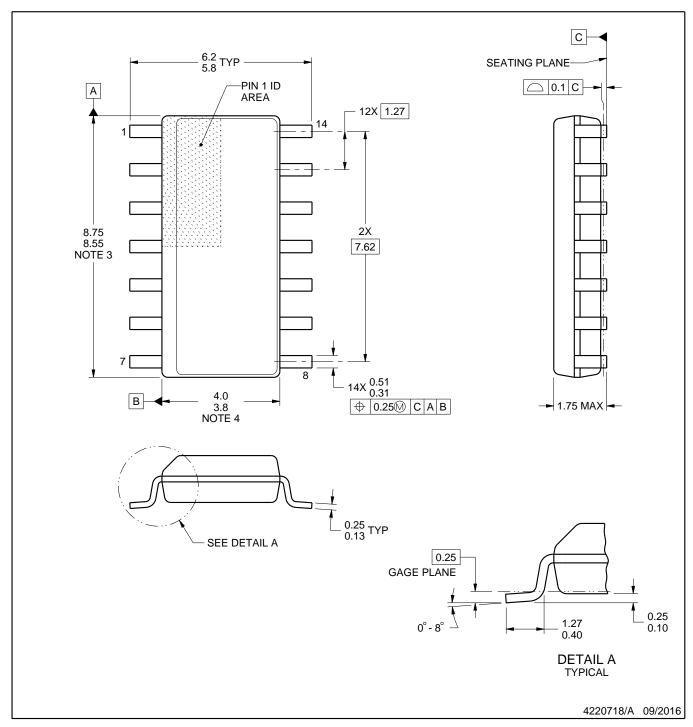


#### \*All dimensions are nominal

| Device          | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-----------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74LV14AMDREP  | SOIC         | D               | 14   | 2500 | 353.0       | 353.0      | 32.0        |
| SN74LV14ATPWREP | TSSOP        | PW              | 14   | 2000 | 353.0       | 353.0      | 32.0        |



SMALL OUTLINE INTEGRATED CIRCUIT



#### NOTES:

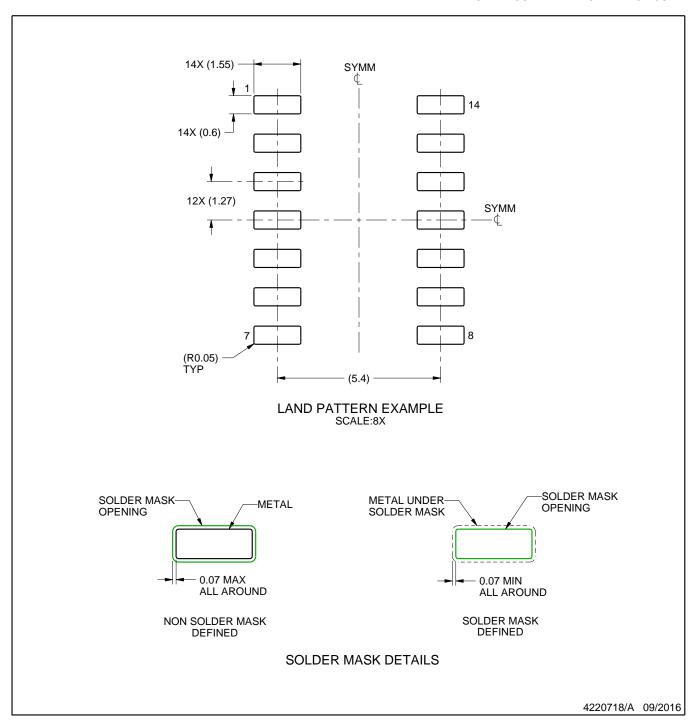
- 1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

  2. This drawing is subject to change without notice.

  3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm, per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm, per side.
- 5. Reference JEDEC registration MS-012, variation AB.



SMALL OUTLINE INTEGRATED CIRCUIT



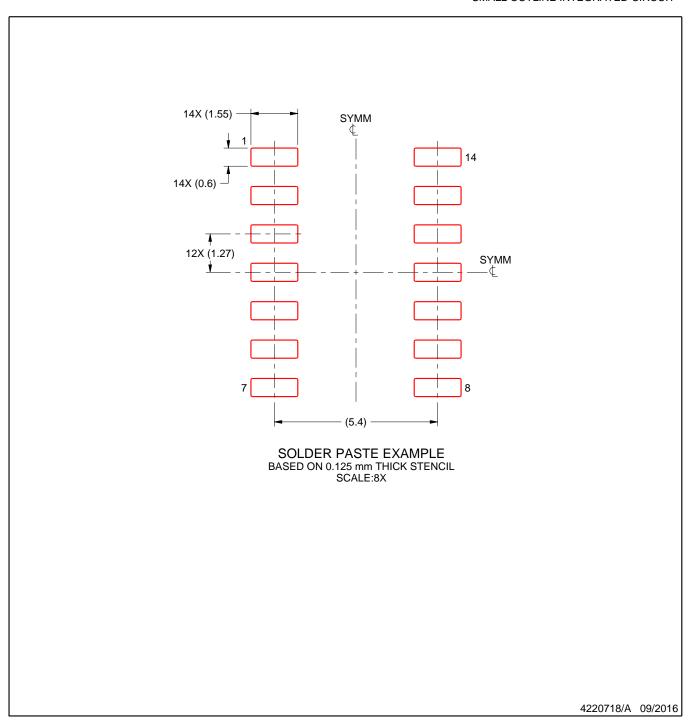
NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SMALL OUTLINE INTEGRATED CIRCUIT



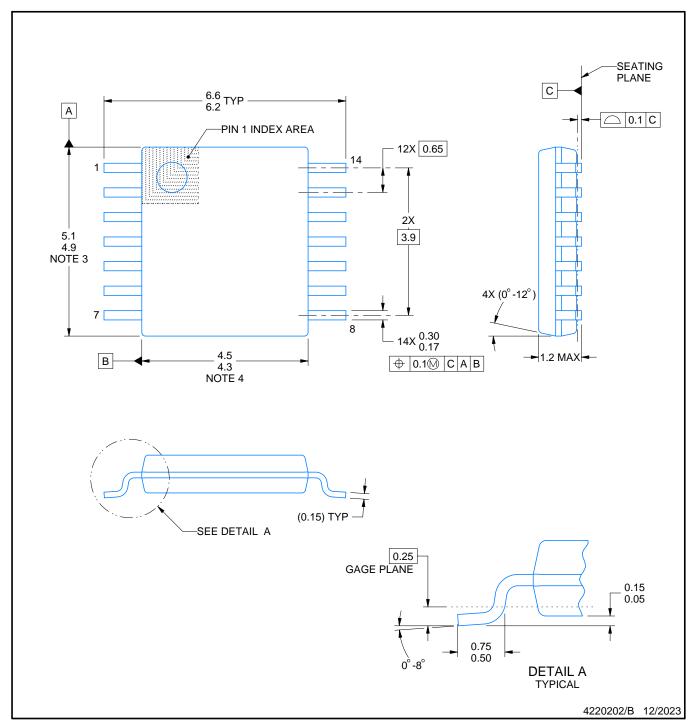
NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.





SMALL OUTLINE PACKAGE



#### NOTES:

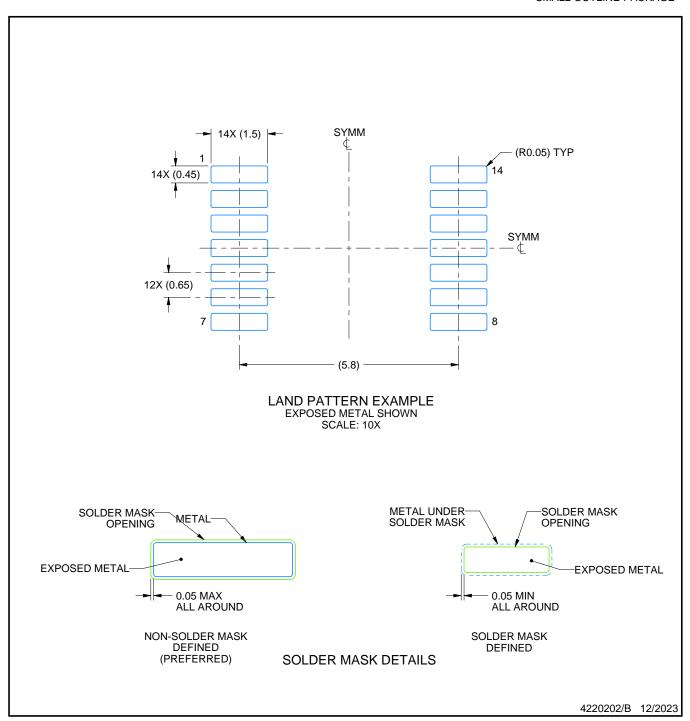
- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

  2. This drawing is subject to change without notice.

  3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
- 5. Reference JEDEC registration MO-153.



SMALL OUTLINE PACKAGE



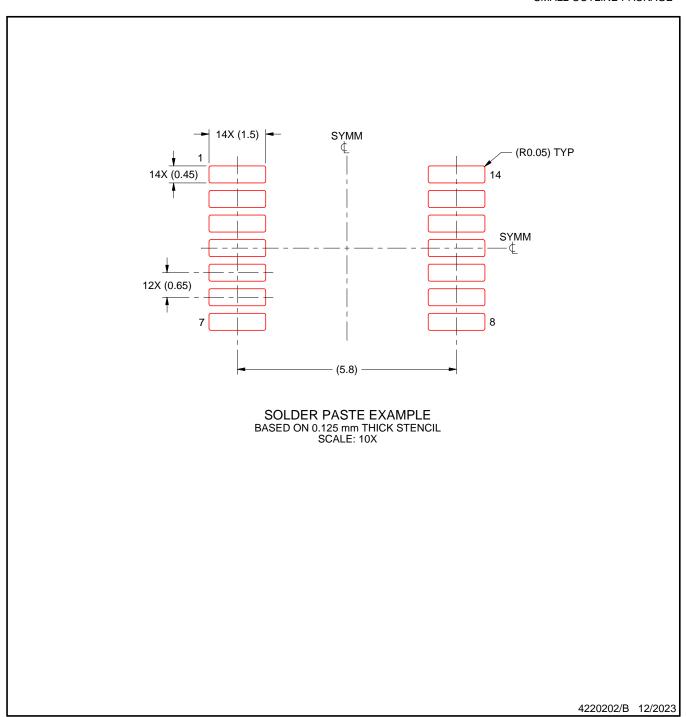
NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SMALL OUTLINE PACKAGE



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



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